

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J-MOS series

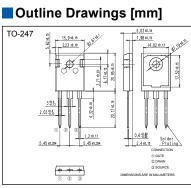
N-Channel enhancement mode power MOSFET

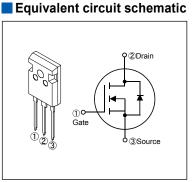
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	VDS	600	V	
Drain-Source voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current	lo	±68	А	Tc=25°C Note*1
		±43	А	Tc=100°C Note*1
Pulsed Drain Current	IDP	±204	А	
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	13.5	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	3194.4	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/µs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	50	A/µs	Note *5
Maximum Power Dissipation	Pp	2.5	W	T₂=25°C
		545	vv	Tc=25°C
Operating and Starage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, IAs=8.1A, L=89.3mH, Vpp=60V, R₀=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-20A, -di/dt=50A/µs, Vob≤300V, Vos peak≤ 600V, Tch≤150°C.

Note *5 : IF≤-20A, dV/dt=15kV/µs, VDD≤300V, VDs peak≤ 600V, Tch≤150°C.

Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I₀=250μA V₅s=0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I₀=250µA V₀s=V₀s		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	lass	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I₀=34A V₀s=10V		-	0.034	0.04	Ω
Gate resistance	RG	f=1MHz, open drain		-	1.3	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =34A V _{DS} =25V	27.5	55	-	S
Input Capacitance	Ciss	V _{DS} =10V	-	7000	-	
Output Capacitance	Coss	V _{GS} =0V	-	14500	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	1300	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	350	-	pF
Effective output capacitance, time related (Note *7)	Co(tr)	V _{GS} =0V V _{DS} =0480V ID=constant	-	1330	-	
Turn-On Time	t _{d(on)}	V _{DD} =400V, V _{GS} =10V I _D =34A, R _G =6.2Ω See Fig.3 and Fig.4	-	40	-	
Turn-On Time	tr		-	107	-	- ns
Turn-Off Time	t _{d(off)}		-	199	-	
tr	tr		-	20	-	
Total Gate Charge	Q _G	V₀₀=480V, I₀=68A V₅₅=10V See Fig.5	-	203	-	-
Gate-Source Charge	Q _{GS}		-	44	-	
Gate-Drain Charge	QGD		-	76	-	nC
Drain-Source crossover Charge	Qsw		-	27	-	

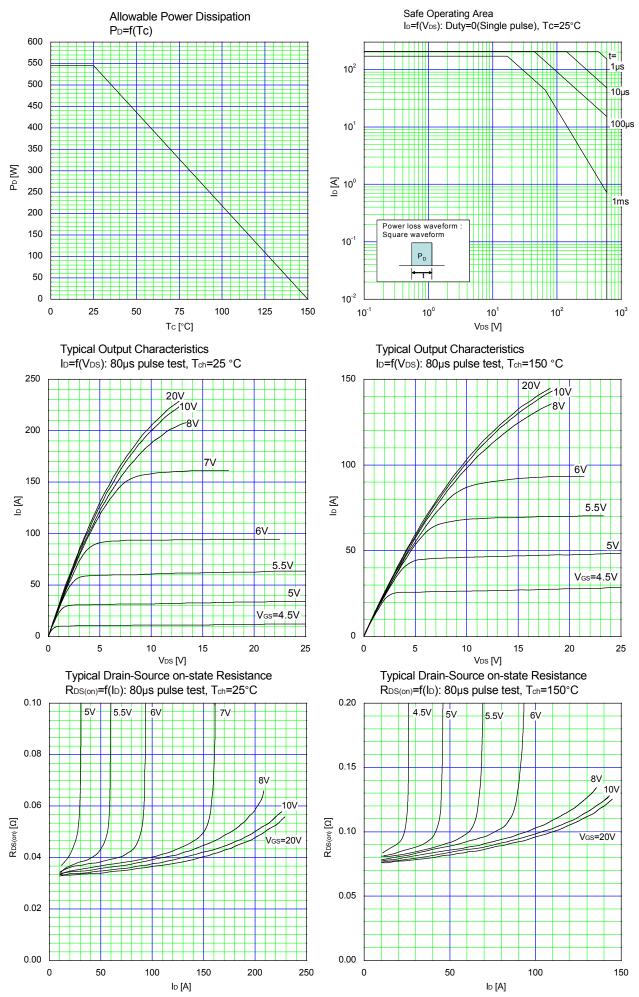
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}.

Reverse Diode

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=19.3mH, T₀=25°C See Fig.1 and Fig.2	13.5	-	-	А
Diode Forward On-Voltage	V _{SD}	IF=68A, VGS=0V Tch=25°C	-	1.0	1.35	V
Reverse Recovery Time	trr	I⊧=20A, V₀s=0V V₀p=300V -di/dt=50A/µs T₀h=25°C See Fig.6		600	-	ns
Reverse Recovery Charge	Qrr		-	8.7	-	μC
Peak Reverse Recovery Current	Irp		-	29	-	А

Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.23	°C/W
Channel to Ambient	Rth(ch-a)	-	-	50	°C/W



100

7

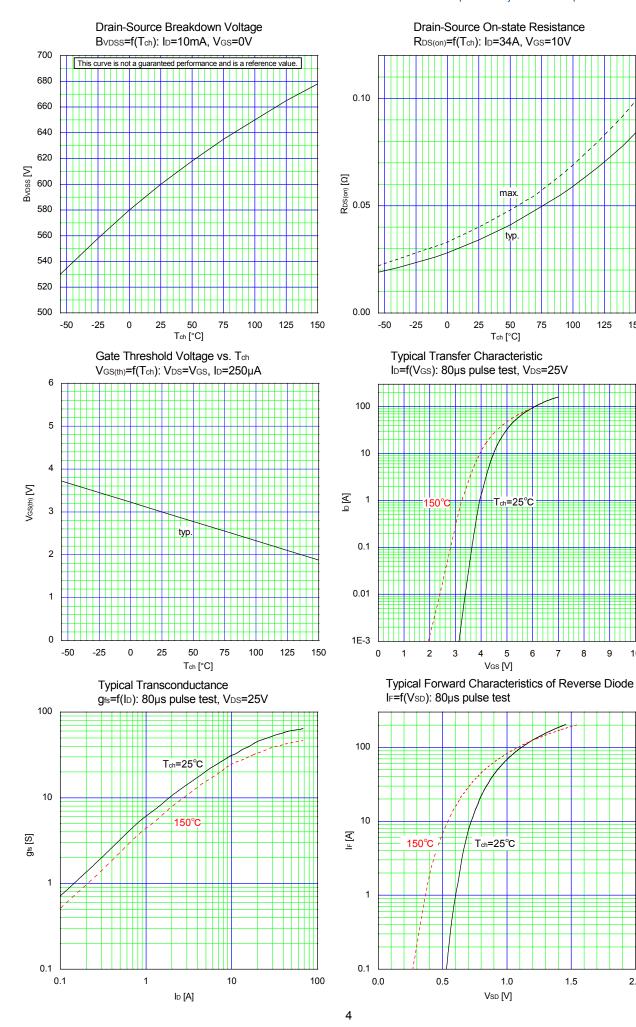
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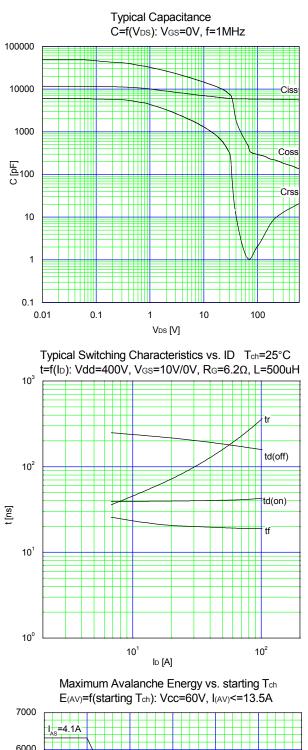
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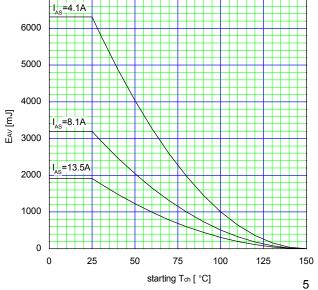
2.0

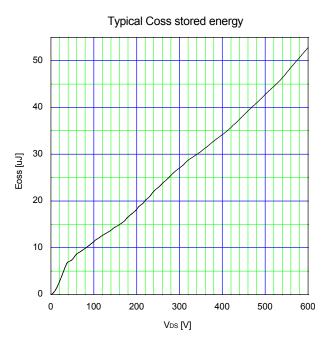
125

150

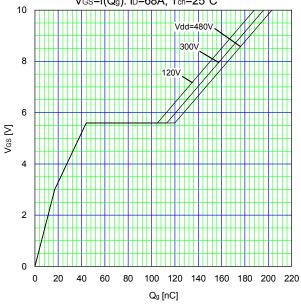




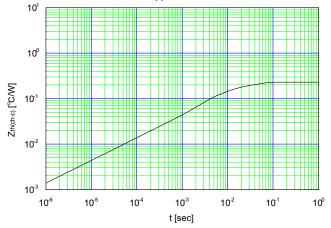


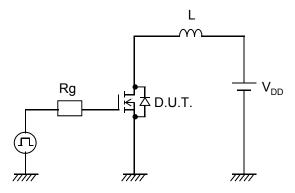


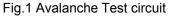
Typical Gate Charge Characteristics VGs=f(Qg): ID=68A, Tch=25°C



Transient Thermal Impedance $Z_{th(ch-c)}=f(t):D=0$







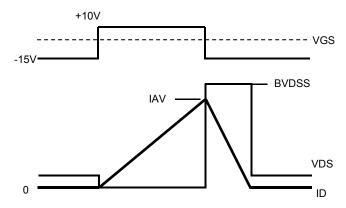


Fig.2 Operating waveforms of Avalanche Test

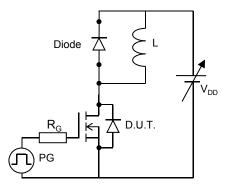


Fig.3 Switching Test circuit

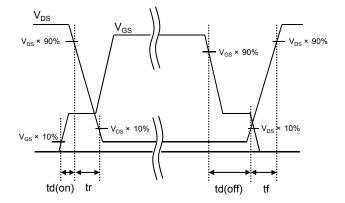


Fig.4 Operating waveform of Switching Test

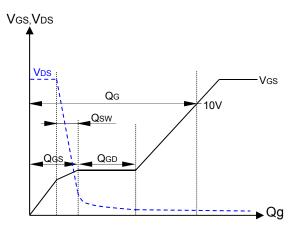


Fig.5 Operating waveform of Gate charge Test

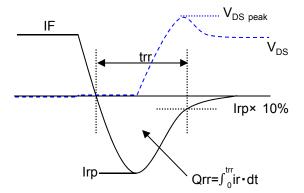
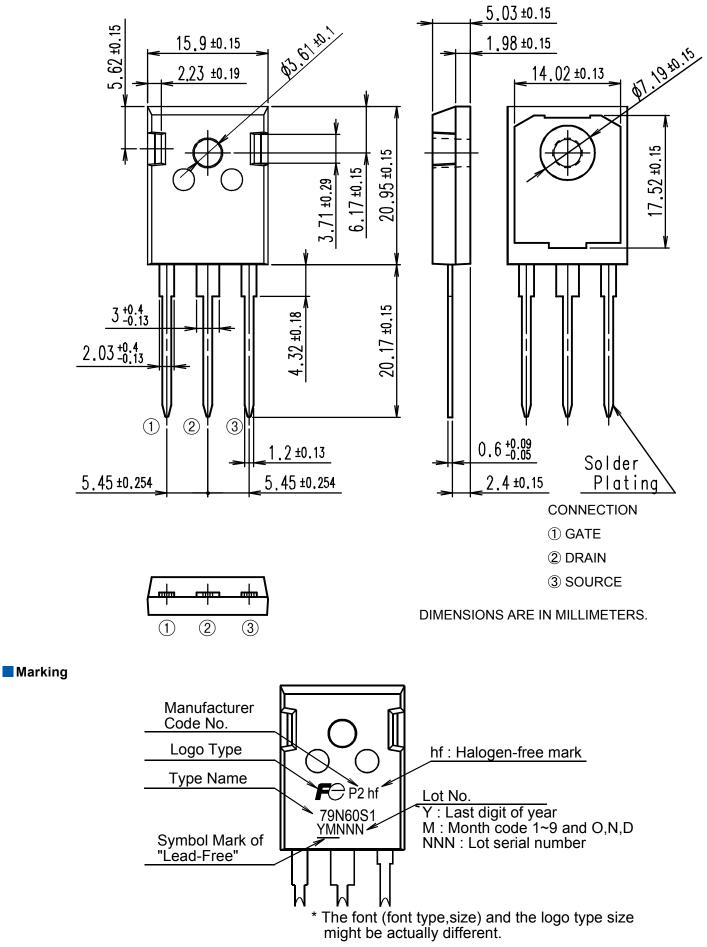


Fig.6 Operating waveform of Reverse recovery Test

Outview: TO-247 Package



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